

**TM05N03I**
**N-Channel Enhancement Mosfet**
**General Description**

- Low  $R_{DS(ON)}$
- RoHS and Halogen-Free Compliant

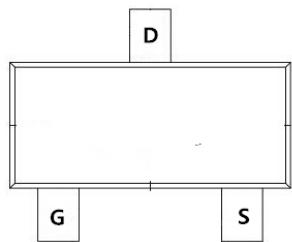
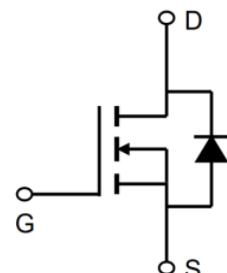
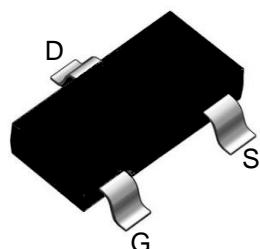
**Applications**

- Load switch
- PWM

**General Features**

$V_{DS} = 30V$   $I_D = 4.5A$   
 $R_{DS(ON)} = 32m\Omega$ (typ.) @  $V_{GS} = 10V$

100% UIS Tested  
 100%  $R_g$  Tested


**I:SOT-23**


Marking: 3400 OR A09T

**Absolute Maximum Ratings ( $T_c=25^\circ C$  unless otherwise noted)**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 12$	V
$I_D @ T_A=25^\circ C$	Continuous Drain Current, $V_{GS} @ 4.5V^1$	4.5	A
$I_D @ T_A=70^\circ C$	Continuous Drain Current, $V_{GS} @ 4.5V^1$	2.8	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	16.4	A
$P_D @ T_A=25^\circ C$	Total Power Dissipation <sup>3</sup>	1.1	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

**Thermal Data**

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient <sup>1</sup>	---	113	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case <sup>1</sup>	---	---	°C/W

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

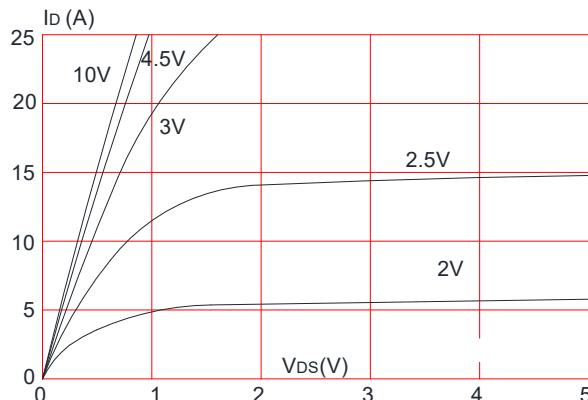
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	30	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ ,	-	-	1.0	$\mu\text{A}$
$I_{\text{GSS}}$	Gate to Body Leakage Current	$V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}= \pm 12\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_D=250\mu\text{A}$	0.5	0.9	1.4	V
$R_{\text{DS}(\text{on})}$	Static Drain-Source on-Resistance note2	$V_{\text{GS}}=10\text{V}$ , $I_D=4\text{A}$	-	32	42	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_D=3\text{A}$	-	36	48	
		$V_{\text{GS}}=2.5\text{V}$ , $I_D=2\text{A}$	-	50	70	
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$	-	285	-	pF
$C_{\text{oss}}$	Output Capacitance		-	33	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	27	-	pF
$Q_g$	Total Gate Charge	$V_{\text{DS}}=15\text{V}$ , $I_D=4\text{A}$ , $V_{\text{GS}}=4.5\text{V}$	-	2.6	-	nC
$Q_{\text{gs}}$	Gate-Source Charge		-	0.6	-	nC
$Q_{\text{gd}}$	Gate-Drain("Miller") Charge		-	0.9	-	nC
<b>Switching Characteristics</b>						
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{DS}}=15\text{V}$ , $I_D=2\text{A}$ , $R_{\text{GEN}}=3\Omega$ , $V_{\text{GS}}=4.5\text{V}$	-	15	-	ns
$t_r$	Turn-on Rise Time		-	42	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		-	16	-	ns
$t_f$	Turn-off Fall Time		-	10	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_s$	Maximum Continuous Drain to Source Diode Forward Current	-	-	4.5	A	
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	16	A	
$V_{\text{SD}}$	Drain to Source Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_s=4\text{A}$	-	-	1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

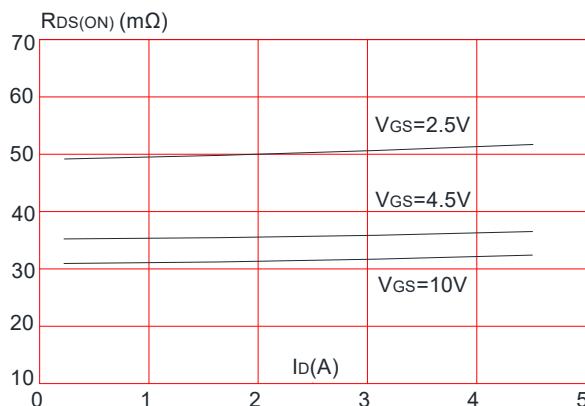
2. Pulse Test: Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 0.5\%$

## Typical Performance Characteristics

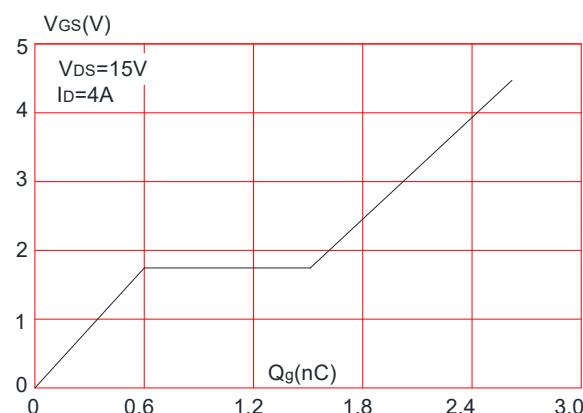
**Figure 1:** Output Characteristics



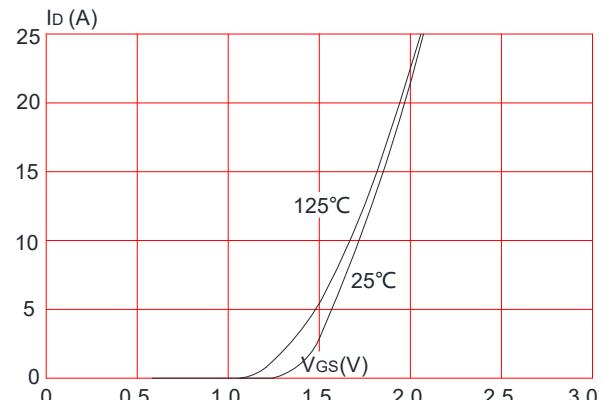
**Figure 3:** On-resistance vs. Drain Current



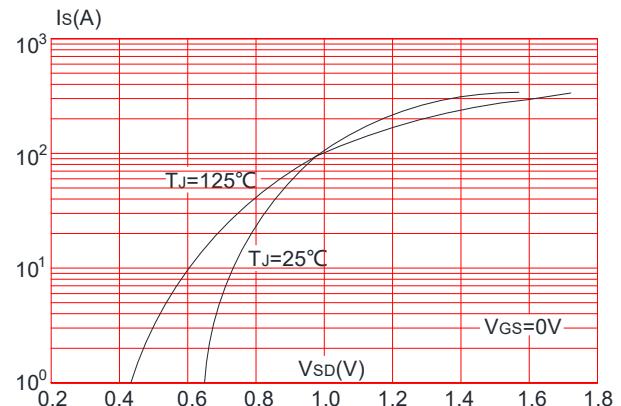
**Figure 5:** Gate Charge Characteristics



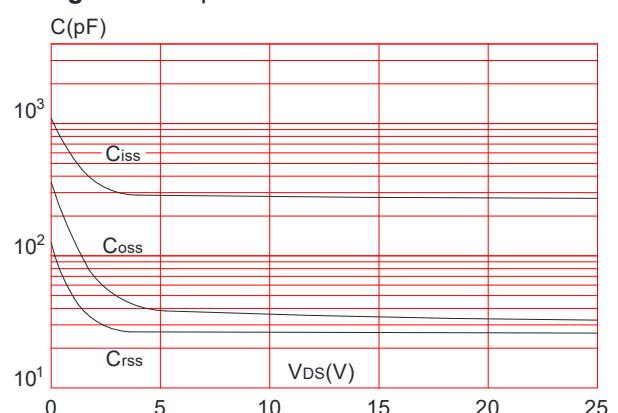
**Figure 2:** Typical Transfer Characteristics



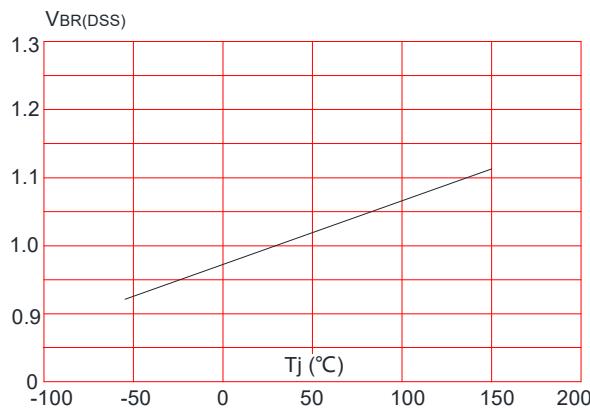
**Figure 4:** Body Diode Characteristics



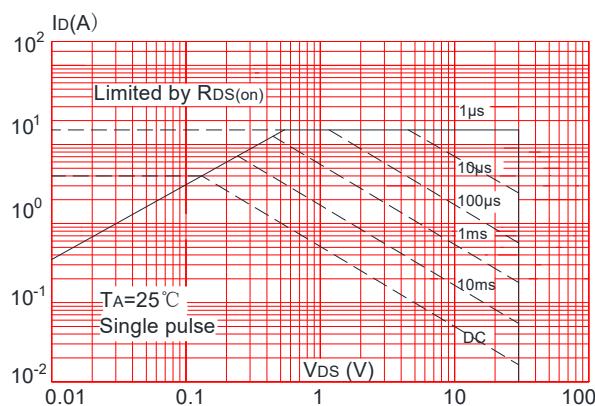
**Figure 6:** Capacitance Characteristics



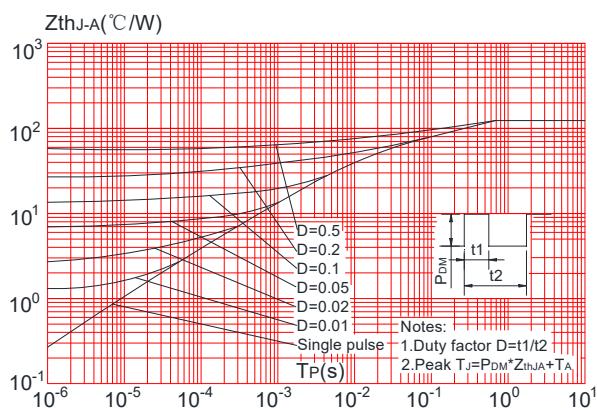
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



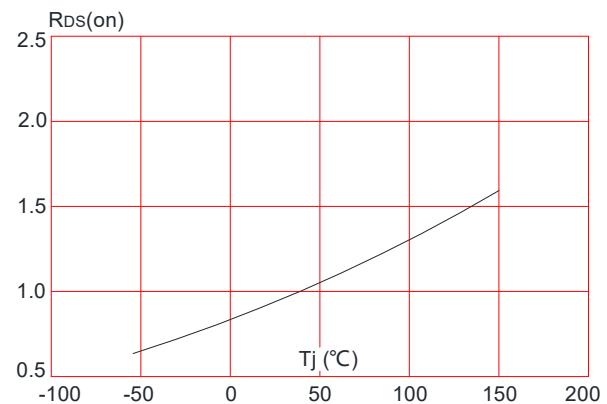
**Figure 9:** Maximum Safe Operating Area



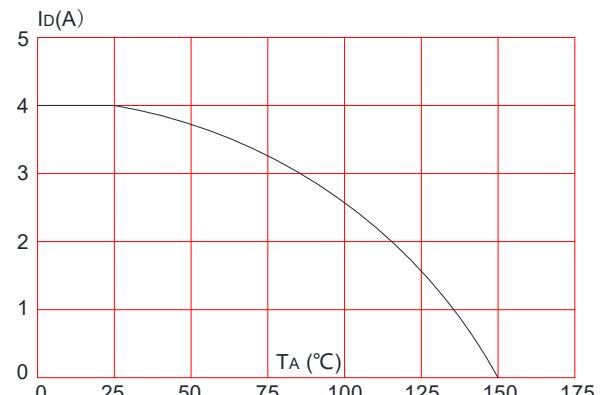
**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



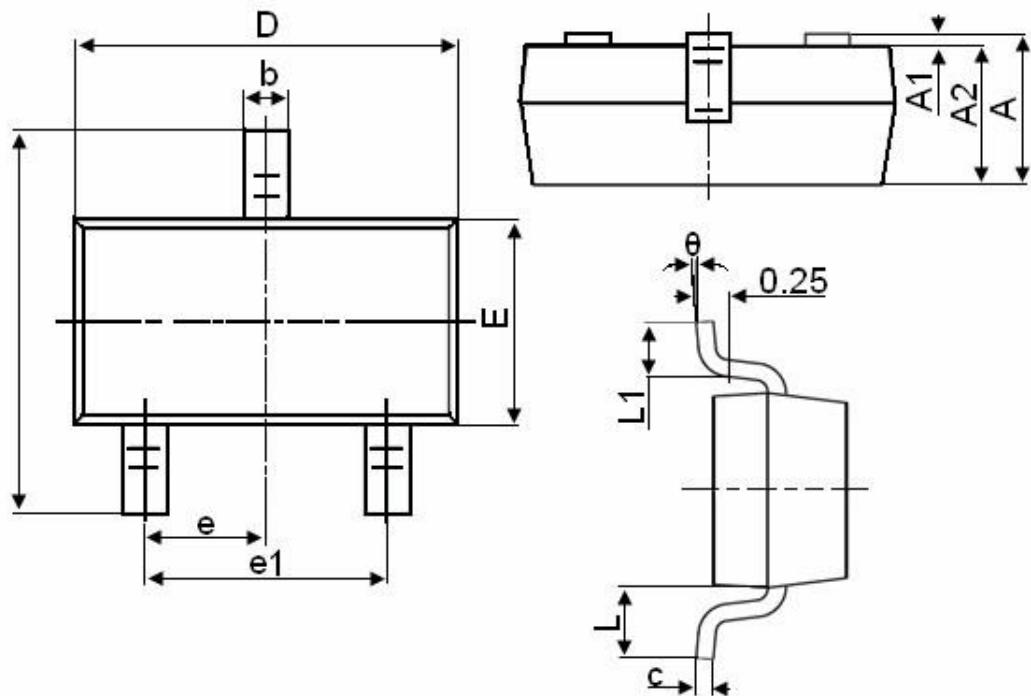
**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature



## Package Information SOT-23



Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e		0.950TYP
e1	1.800	2.000
L		0.550REF
L1	0.300	0.500
$\theta$	$0^\circ$	$8^\circ$